



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Patent No.

: 7,267,895 B2

Issue Date

September 11, 2007

Inventors

Sadayuki Shoudai et al.

Docket No.

: 891050.401

Date

: May 8, 2008

Mail Stop Certificate of Correction Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Certificate

MAY 1 4 2008

of Correction

REQUEST FOR CERTIFICATE OF CORRECTION

Commissioner for Patents:

A Certificate of Correction is respectfully requested in the above-identified patent. The following errors have been made:

Column 16, claim 15, line 51, the section "has a thickness of $0.15~\mu m$." is incorrect. As set forth in the Amendment dated April 30, 2007, this section should read as -- has a thickness of $0.5~\mu m$. --.

Please note that due to claim cancelling and renumbering, Claim 40 of the April 30, 2007 Amendment became Claim 15 in the issued patent.

Attached is the certificate of correction, which indicates the corrections to be made, by reference to the column and line numbers in the printed patent. Because the errors were made by the Patent Office, no fee is necessary. However if they are determined to be our errors, the Director is hereby authorized to charge payment of any fees associated with this communication to Deposit Account No. 19-1090.

Respectfully submitted,

SEED/Intellectual Property Law Group PLLC

Dennis M. de Guzman Registration No 41,702

DMD:pgr

Enclosures:

Certificate of Correction Postcard

SEED Intellectual Property Law Group PLLC 701 Fifth Avenue, Suite 5400 Seattle, Washington 98104-7092

Phone: (206) 622-4900 Fax: (206) 682-6031

1161551_1.DOC



UNITED STATES PATENT AND TRADEMARK OFFICE CERTIFICATE OF CORRECTION

PATENT NO

: 7,267,895 B2

DATED

: September 11, 2007

INVENTORS

: Sadayuki Shoudai et al.

It is certified that an error appears in the above-identified patent and that said Letters Patent are hereby corrected as shown below:

Column 16

Line 51, the section "has a thickness of 0.15 μ m." is incorrect. As set forth in the Amendment dated April 30, 2007, this section should read as -- has a thickness of 0.5 μ m. --.

MAILING ADDRESS OF SENDER:

Dennis M. de Guzman Seed Intellectual Property Law Group PLLC 701 Fifth Avenue, Suite 5400 Seattle, Washington 98104 PATENT NO.

7,267,895 B2

Find DIVED-USPTO

No. of additional copies

MAY 1 4 2008

Burden hour Statement: This form is estimated to take 1.0 hour to complete. Time will vary depending upon the needs of the individual case. Any comments on the amount of time you are required to complete this form should be sent to the Chief Information Officer, Patent and Trademark Office, Washington, DC 20231. DO NOT SEND FEES OR COMPLETED FORMS TO THIS ADDRESS. SEND TO: Assistant Commissioner for Patents, Washington, DC 20231.